From-HENKEL CORPORATION PATENT DEPT,

P.05/08 F-692 T-706

Serial No. 09/877,372 Docket No. H 4858

Amendments to the Claims:

Claims 1-4 (withdrawn).



- (currently amended) A method for gluing a bandlike covering (4) or film onto a narrow face (3) of a board element (2) or a profile bar having a surface of straight or profiled cross section with an adhesive, the covering (4) or film being pressed onto the narrow face (3) or profile bar by means of at least one pressure element (7), wherein the covering (4) or film is pressed on by means of a pressure element (7) which has an elastically deformable pressure face (30) that deformably matches and exerts uniform pressure on [matched to] the shape of the narrow face (3) or of the profile bar.
- 6. (original) The method of claim 5, wherein the adhesive is a hot melt adhesive.
- (original) The method of claim 5, wherein the board element 7. comprises chipboard, fiber board, or solid wood board.
- The method of claim 5, wherein the deformable face 8. (new) comprises an elastic band.
- The method of claim 5, wherein the deformable face 9. (new) comprises a spring-steel band.